

US0D1018495S

(12)

United States Design Patent

Tsubone et al.

(10)

Patent No.:

US D1,018,495 S

(45)

Date of Patent:

** Mar. 19, 2024

(54)

HEADPHONE

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(71)

Applicant: Audio-Technica Corporation, Tokyo (JP)

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(72)

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(**)

Term: 15 Years

Primary Examiner — Paula Allen Greene

(21)

Appl. No.: 29/793,275

(74) Attorney, Agent, or Firm — WCF IP

(22)

Filed: Mar. 17, 2022

(30)

Foreign Application Priority Data

Aug. 31, 2021 (JP) 2021-018712

(51)

LOC (14) Cl. 14-01

(52)

U.S. Cl.
USPC D14/205

(58)

Field of Classification Search

USPC D14/205, 206; D29/112; 2/209;
381/380–381, 374, 370; 455/575.2
CPC H04R 25/00; H04R 25/02; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
5/0335; H04R 1/1083; H04R 1/10; H04R
1/105; H04R 1/1091
See application file for complete search history.

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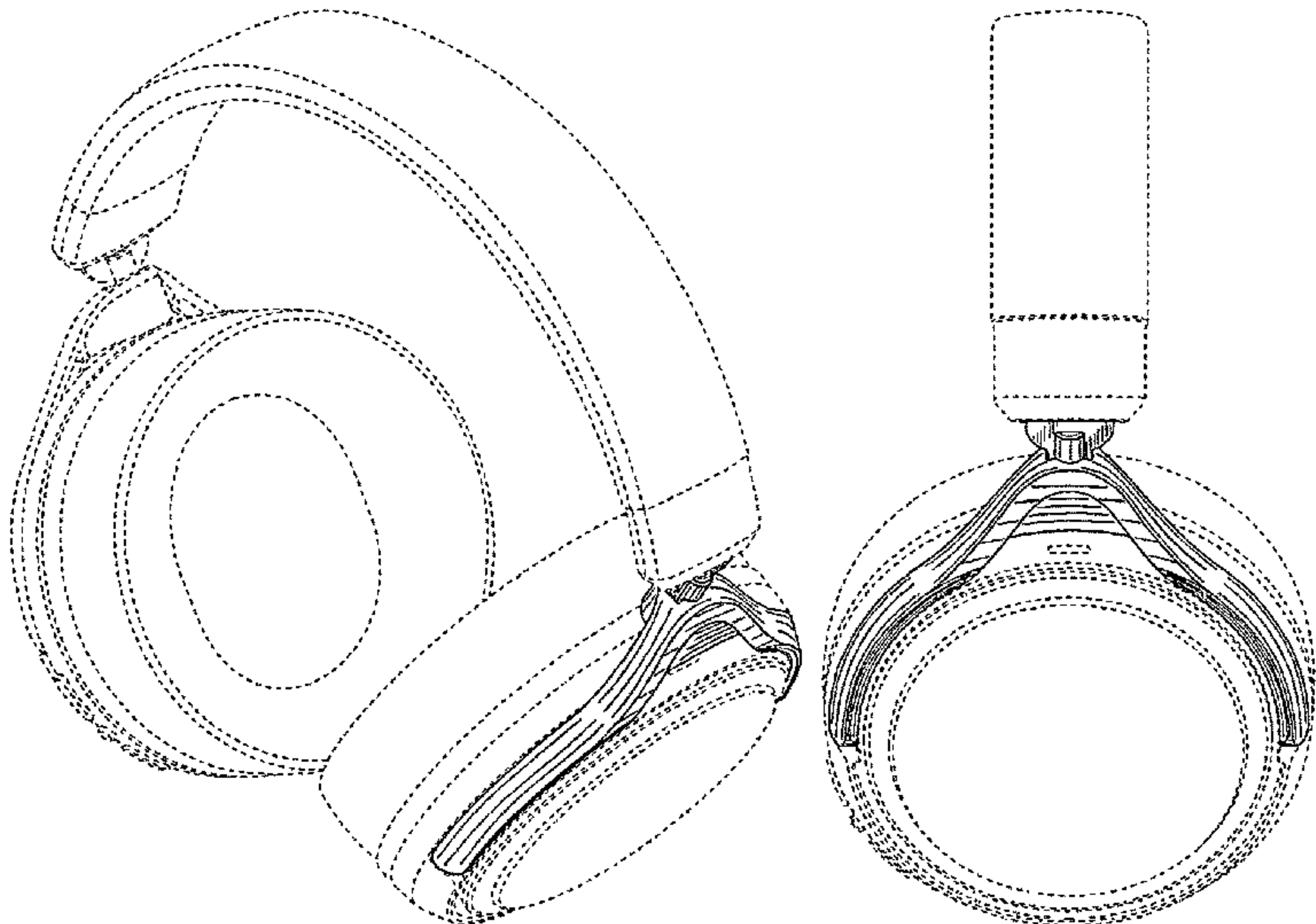
CLAIM

The ornamental design for a headphone, as shown and described.

DESCRIPTION

FIG. 1 is a front side perspective view of a headphone showing the new design;
FIG. 2 is a rear side perspective view of the headphone;
FIG. 3 is a front elevational view of the headphone;
FIG. 4 is a rear elevational view of the headphone;
FIG. 5 is a top plan view of the headphone;
FIG. 6 is a bottom plan view of the headphone;
FIG. 7 is a right side elevational view of the headphone;
FIG. 8 is a left side elevational view of the headphone;
FIG. 9 is an enlarged left side perspective view of the headphone of FIG. 3 as seen from arrow 9 of FIG. 3; and,
FIG. 10 is an enlarged partial view of the headphone taken from FIG. 6.
The dashed broken lines in the drawings depict portions of the headphone that form no part of the claimed design.
The dot dot dash broken lines surrounding portions of the headphone in FIG. 6 and illustrated in the enlarged view of FIG. 10 form no part of the claimed design.

1 Claim, 10 Drawing Sheets



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FIG. 1

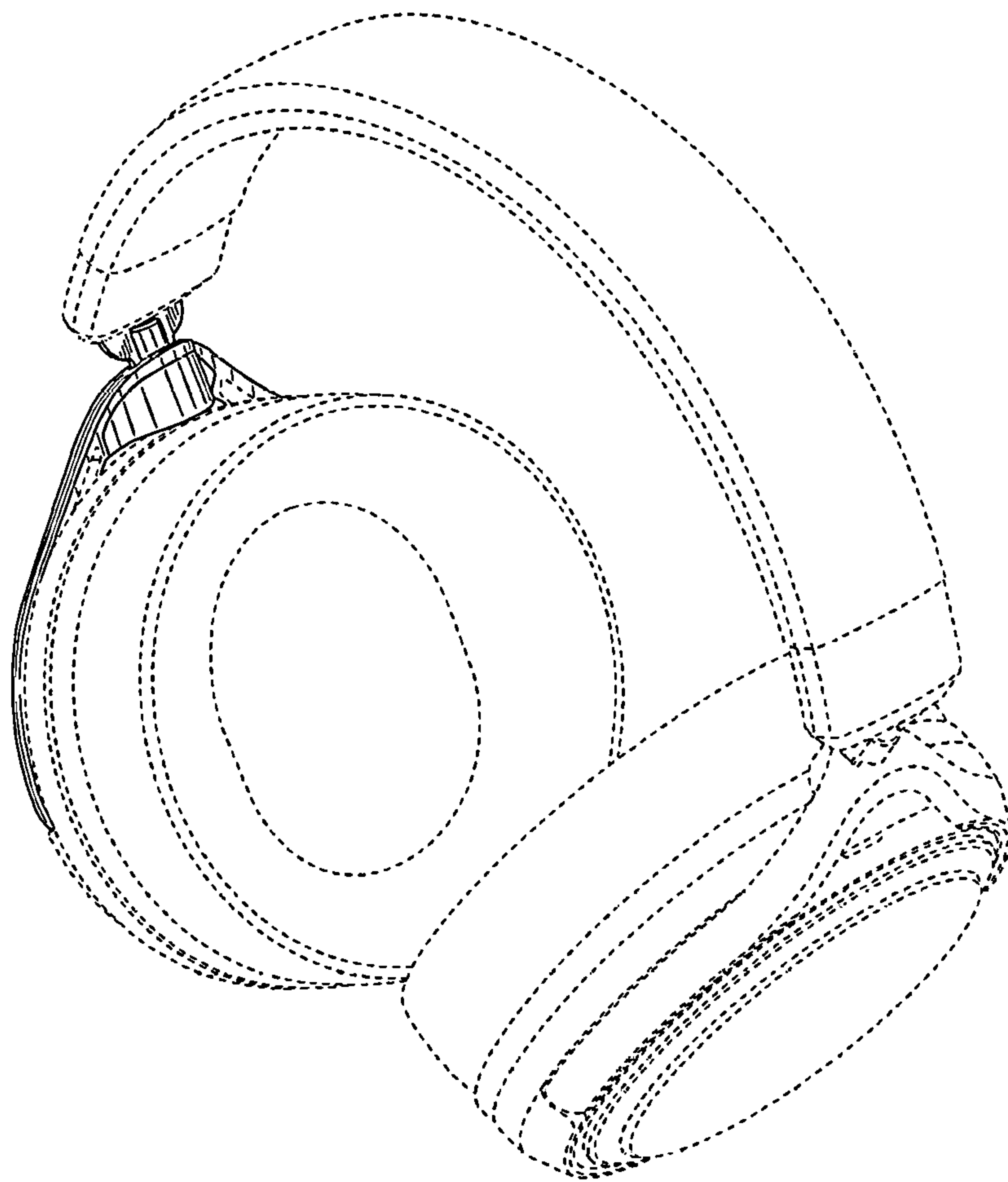


FIG. 2

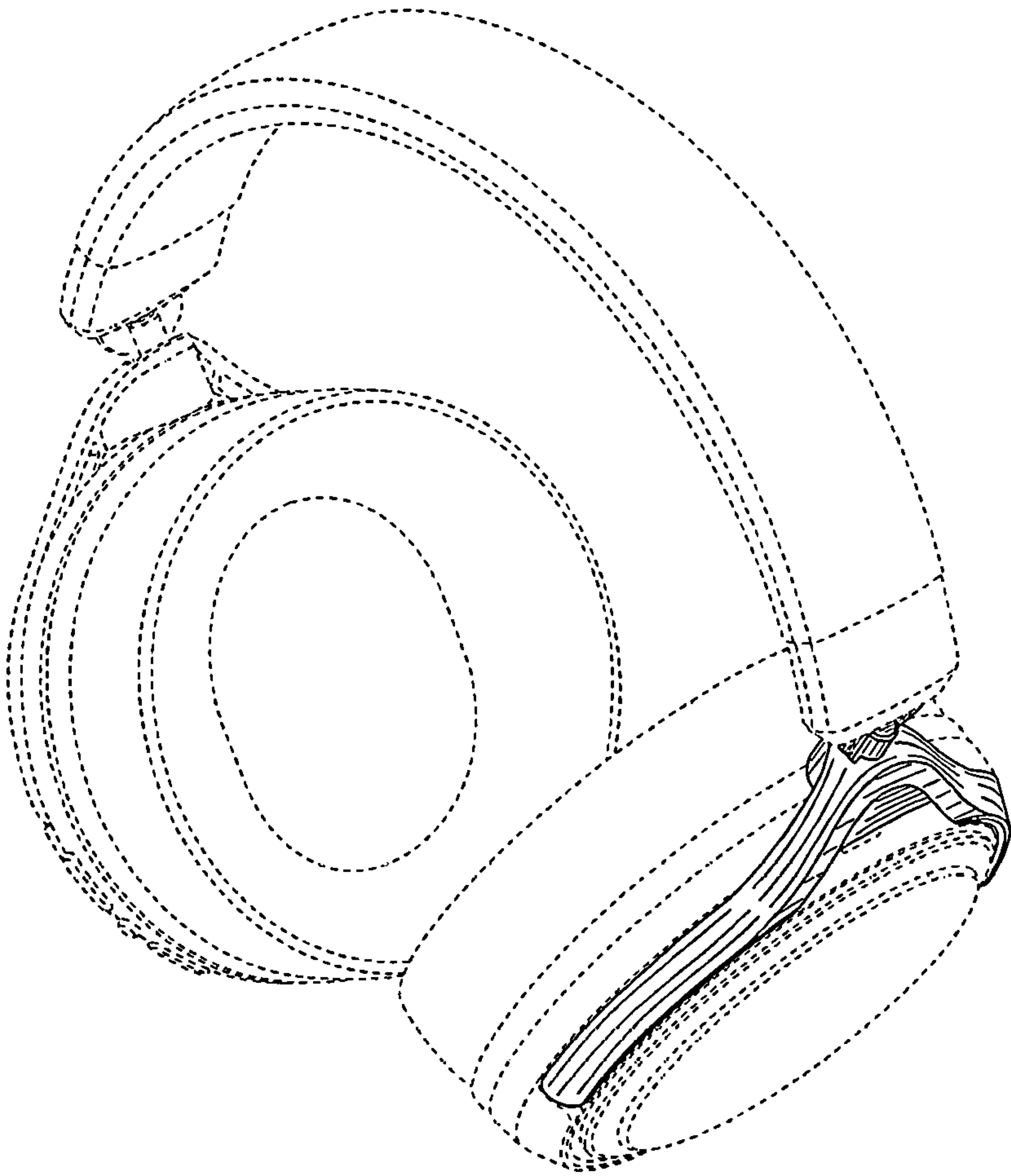


FIG. 3

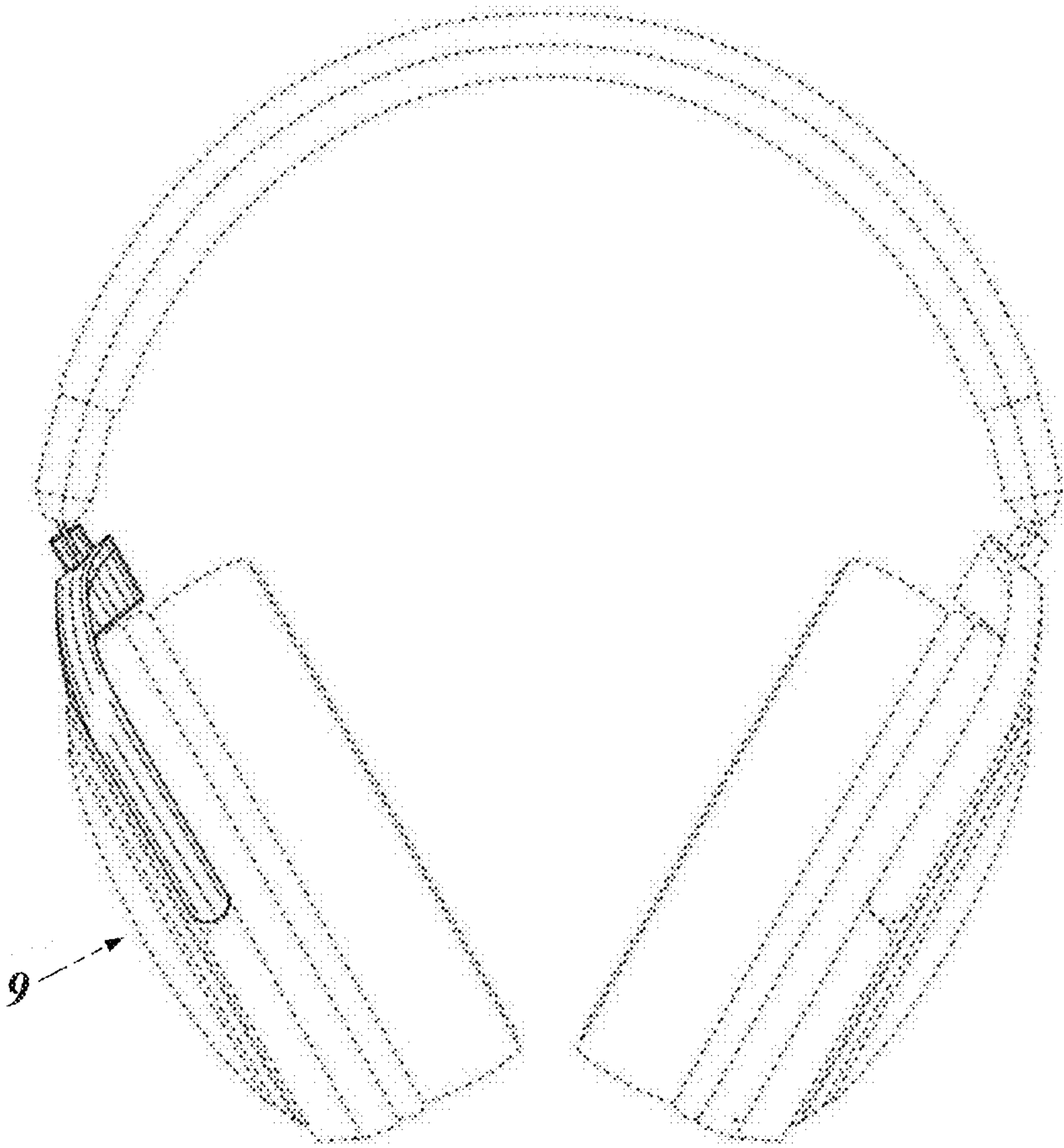


FIG. 4

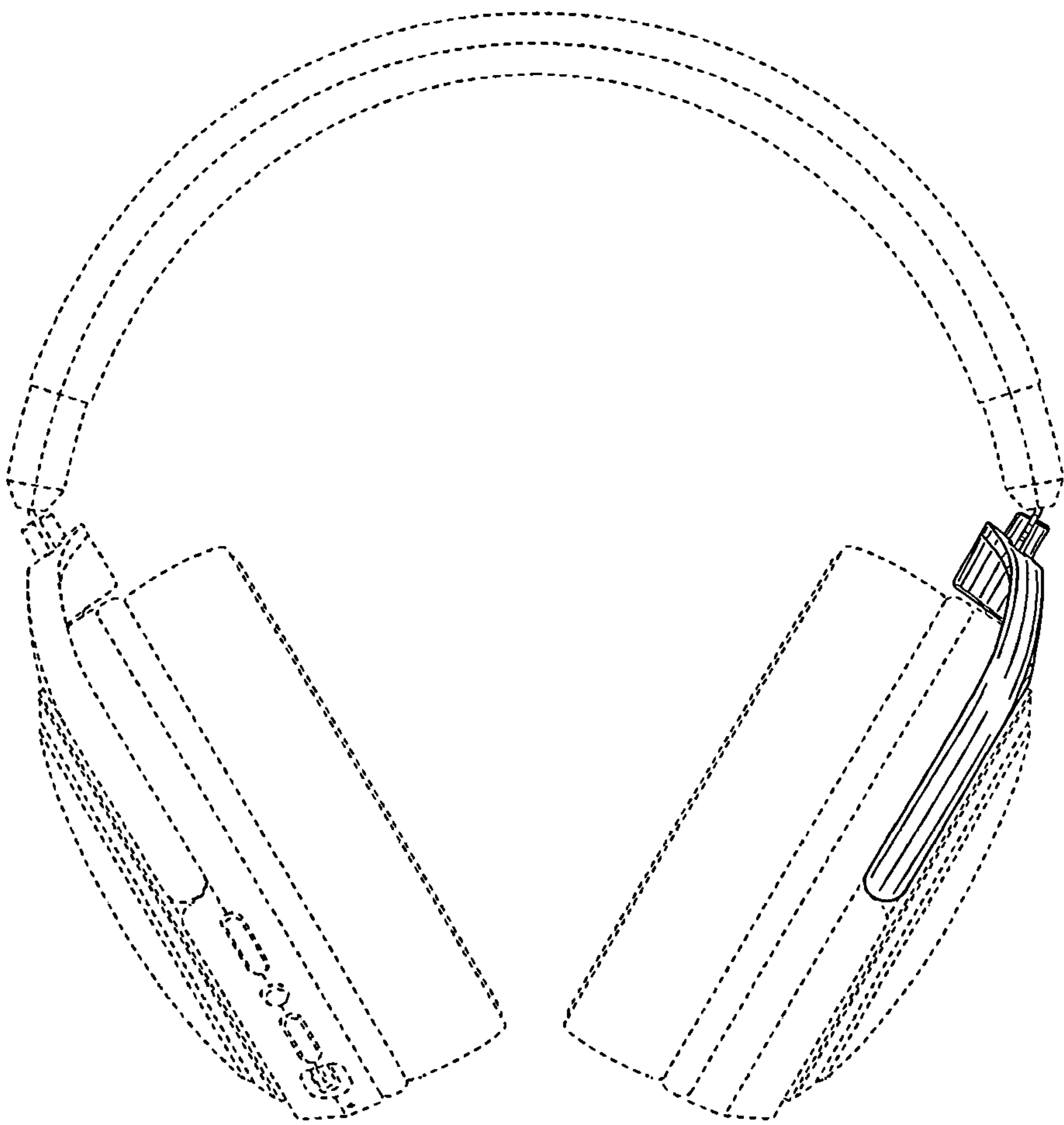


FIG. 5

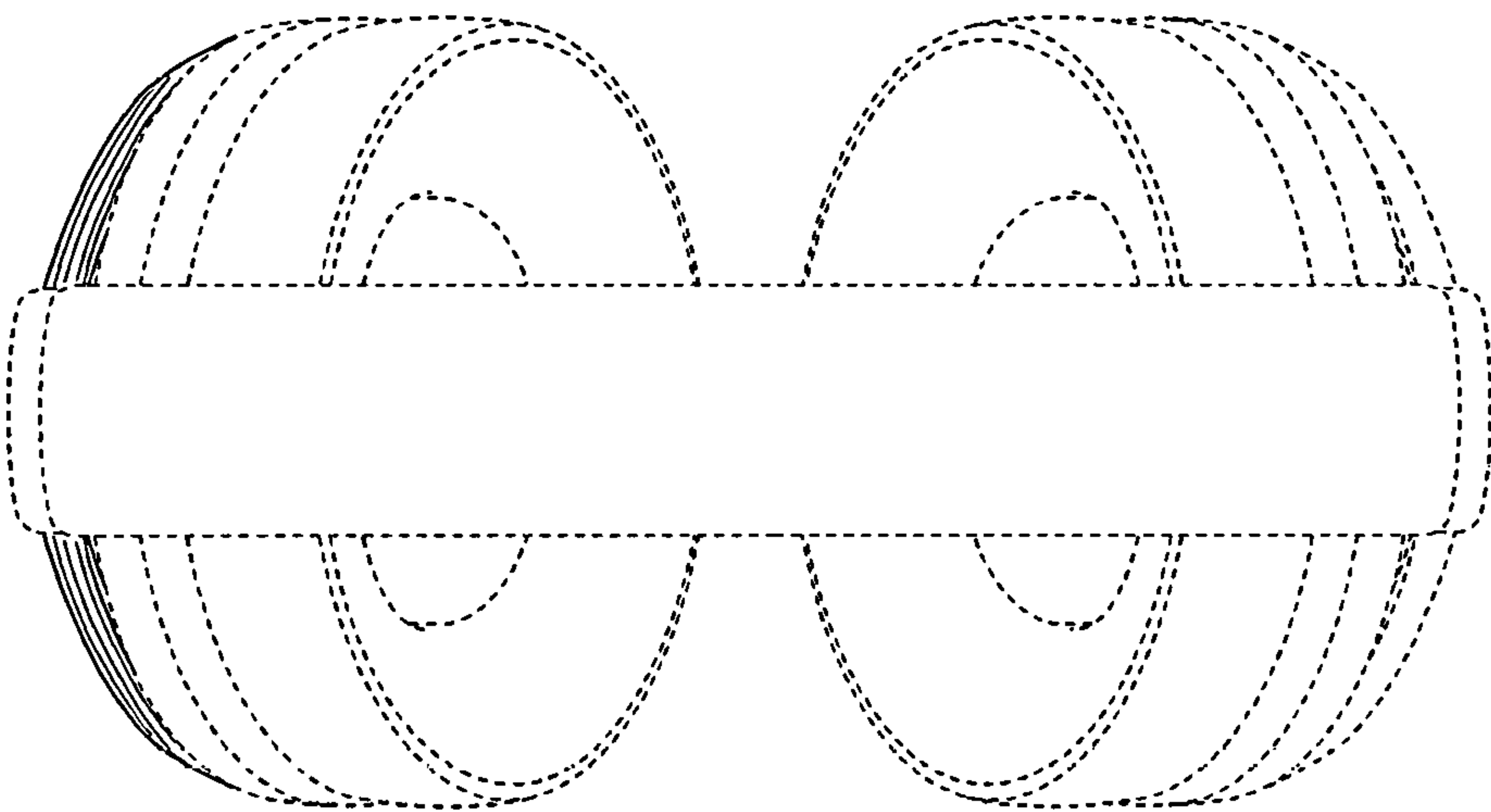


FIG. 6

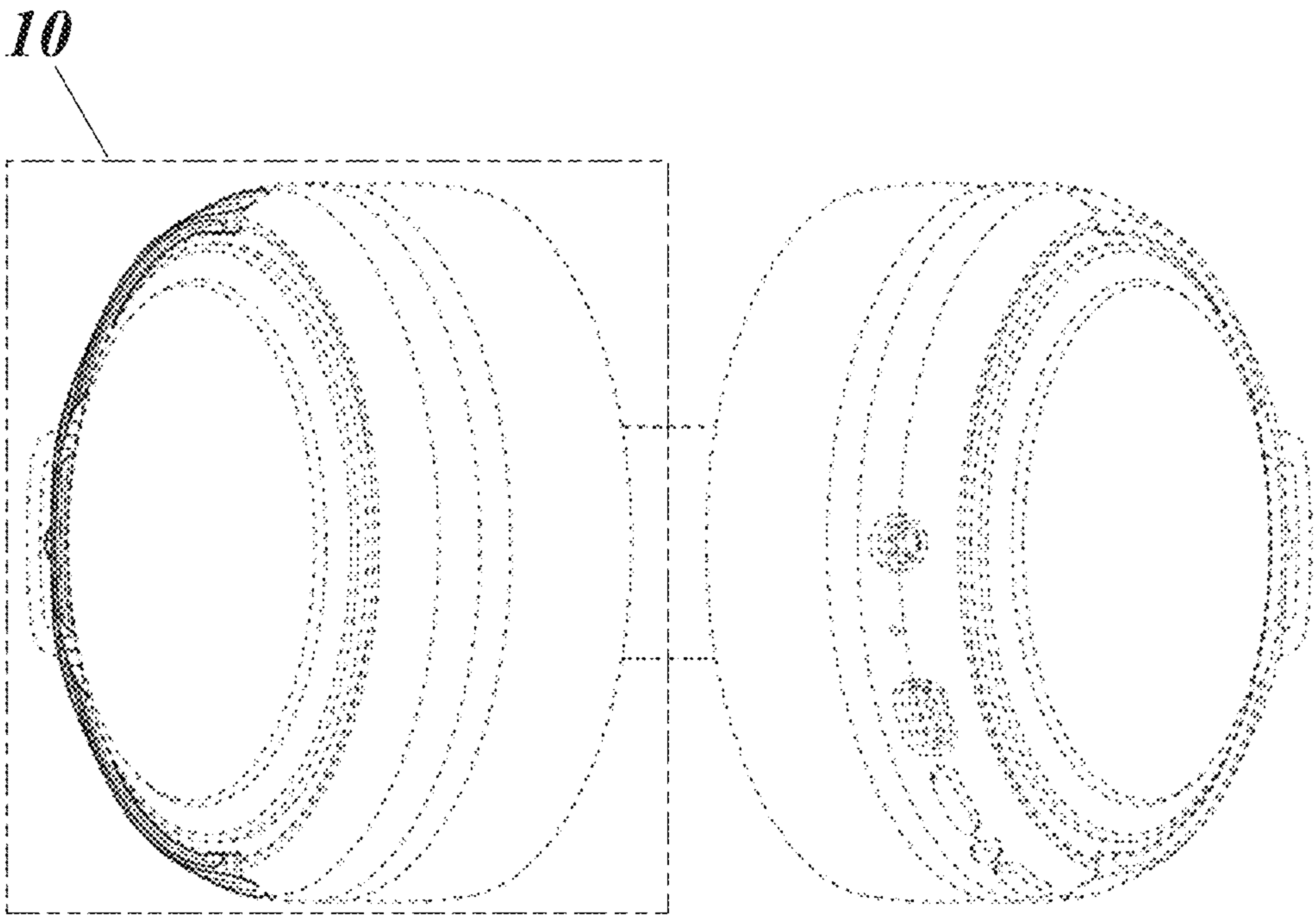


FIG. 7

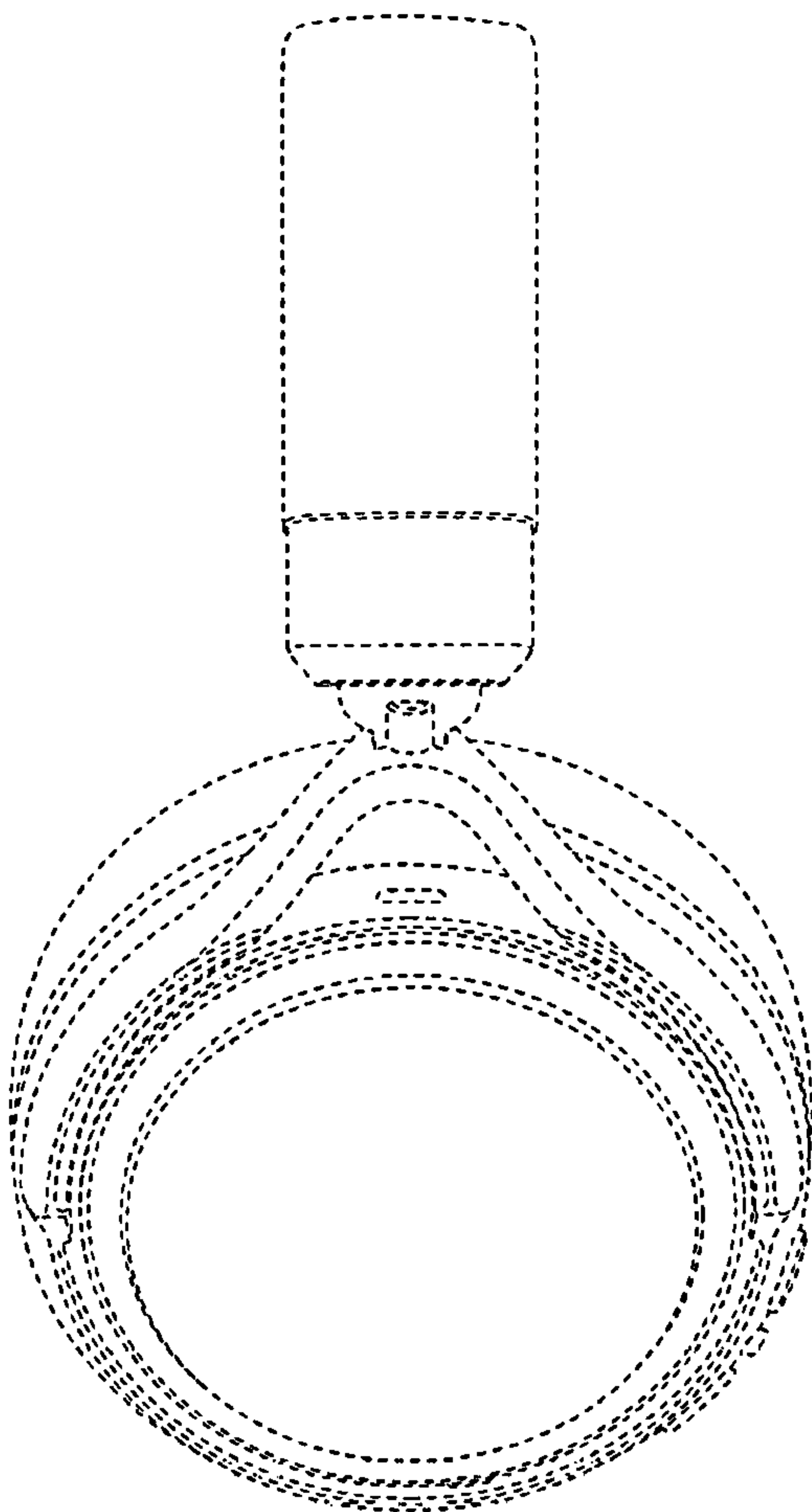


FIG. 8

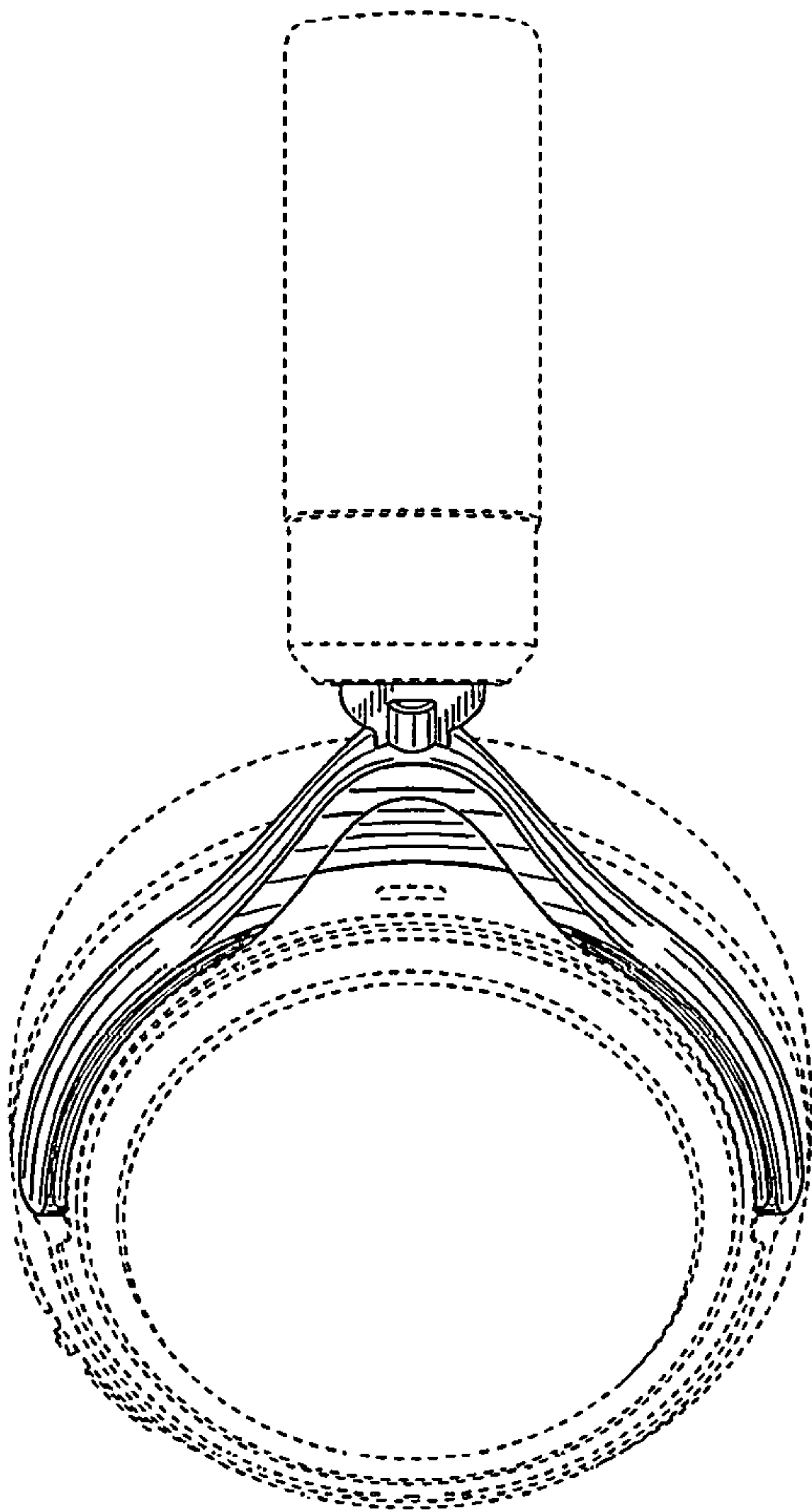


FIG. 9

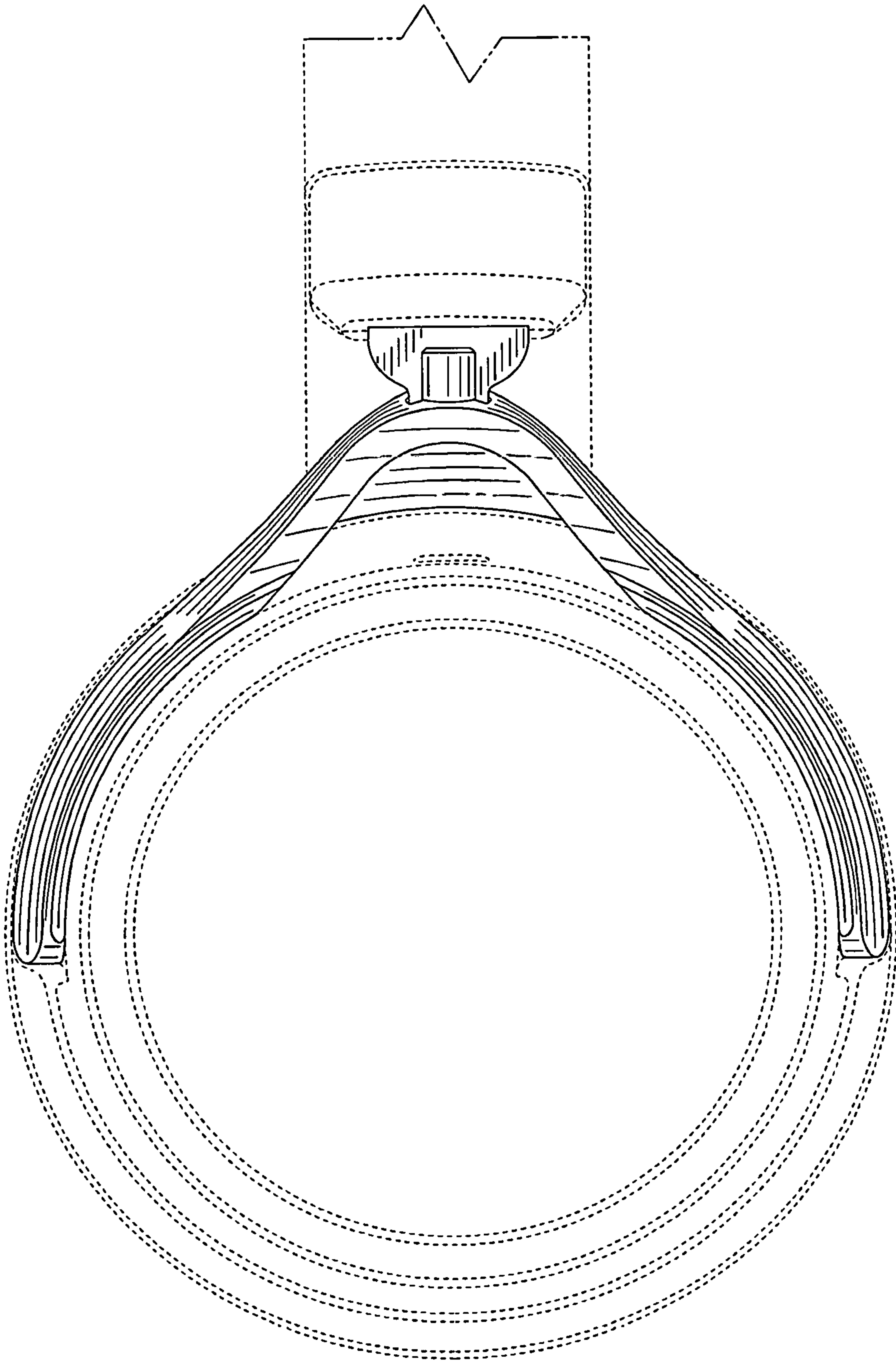
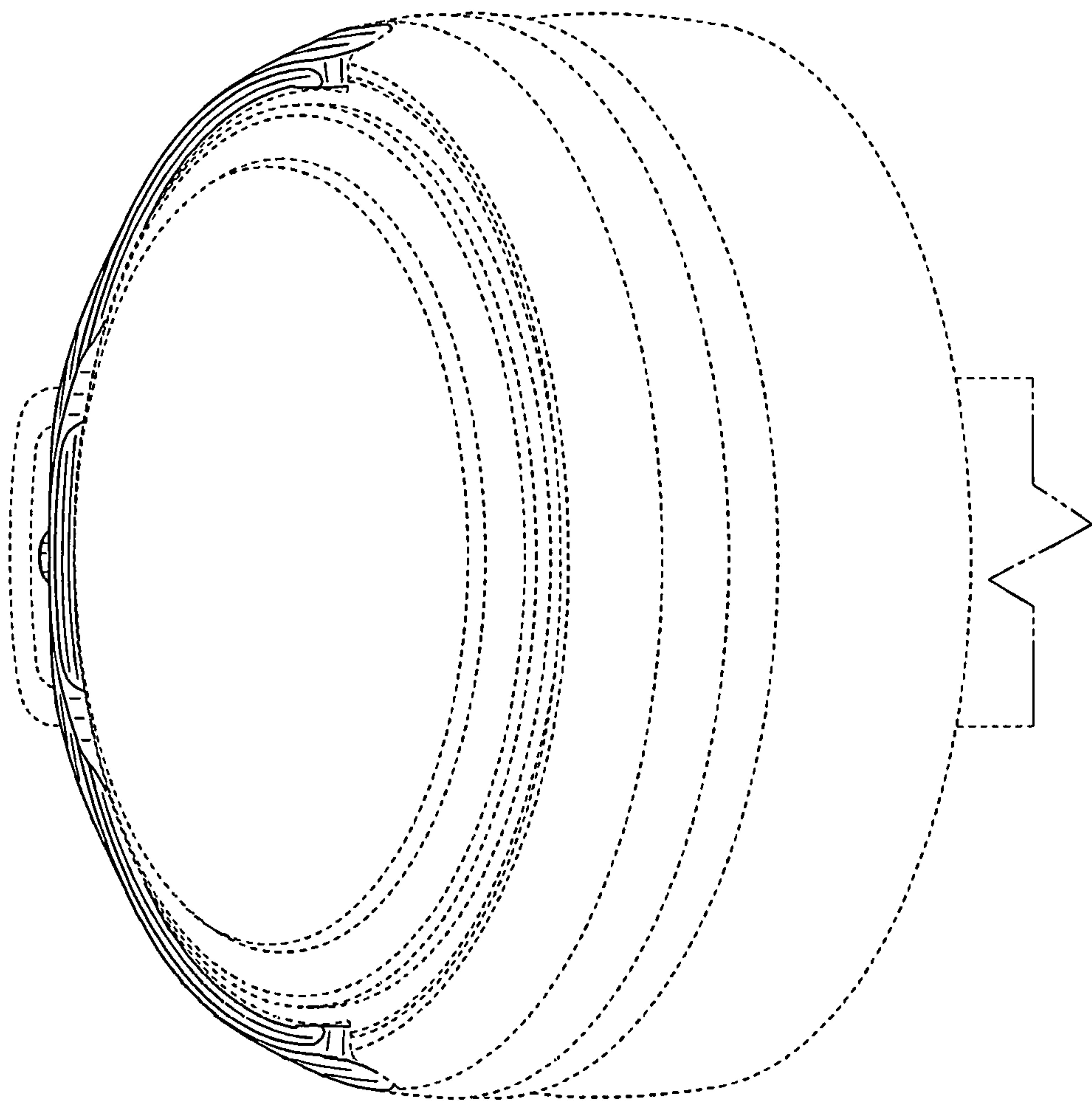


FIG. 10



UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : D1,018,495 S
APPLICATION NO. : 29/793275
DATED : March 19, 2024
INVENTOR(S) : K. Tsubone et al.

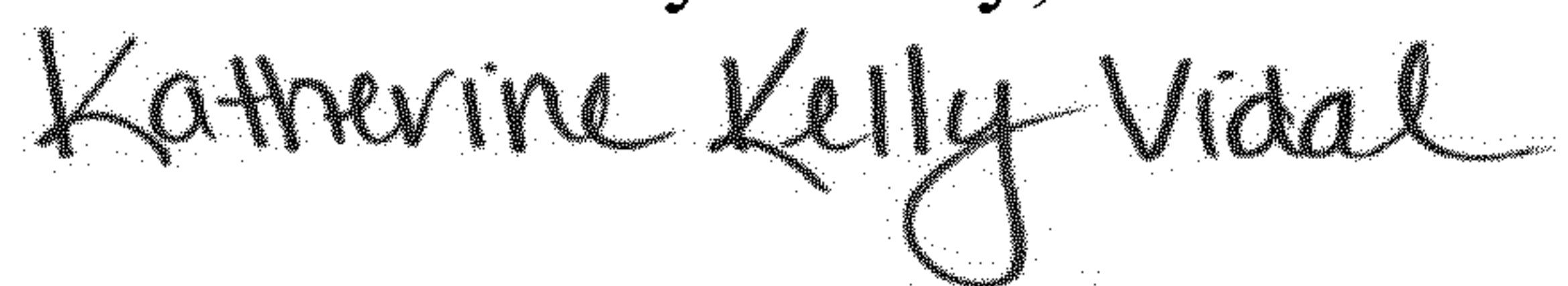
Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the Title Page

Please correct Item (22) the filing date of the application to read February 25, 2022.

Signed and Sealed this
Second Day of July, 2024



Katherine Kelly Vidal
Director of the United States Patent and Trademark Office